

Mylar Speaker Specification

Series FN1313IA

Model Number: FN1313IA085008LFMP-001

Version 1.0

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1. Purpose and the Scope

This document contains the specific specifications (electrical and mechanical), inspection standard and the reliability standard for the purpose of the customer's approval.

2. Description

SMD Mylar Speaker.

3. Applications

Feature Telephone, Cordless Phone, Computer, Instrument etc.

4. Product Origin

In China

5. Test Conditions

Test should be made under the conditions of room temperature ($20 \pm 10 \circ C$) normal humidity ($60 \pm 20 \%$) and normal atmospheric pressure. In the case, however, that the judgment is questionable the test conditions are to be changed to room temperature $20 \pm 2 \circ C$, relative humidity $60 \sim 70 \%$ and normal atmospheric pressure.

6. Ozone Guarantee

Certificate on the elimination of ozone layer destroying substances such as Freon.

7. Quality Protection

The specifications of the mentioned model are based on this document. Other specifications outside than this document must be discussed with us before we insert into this approval document. It means that we will not guarantee the specifications outside than this approval document.

8. Warranty

The warranty period will commence upon the date of the receipt of the parts from FLEZON. In the event that the warranty is not specified on the purchasing order, the warranty period shall be half year from the date of delivery.



9. Soldering Conditions

The speaker by FLEZON should not be exposed to extremely high temperatures for prolonged period of time. As excessive heat will degrade the internal structure of the unit, soldering should be conducted as quickly as possible.

Recommended temperature and time for soldering Hand soldering (for ABS, Hi-Temp ABS, FR ABS, Nylon) 300 ° C Thermal iron 2 seconds

10. Washing Conditions

The products mentioned with "remove after washing" could be washed by our recommended solvent.

11. Flux Removing Solvents

In the view of the recent requirement for total elimination of ozone-depleting chemicals, we have decided to recommend our customers to use deionized water for their cleaning process at the condition given below, instead of "CFC" that was conventionally used.

Cleaning solvent: deionized waterSolvent temperature: $55 \pm 5 \circ C$ Immersion time: 5 ± 0.5 minutes

12. Signal Input Polarity

When a positive dc voltage is applied to the terminal marked (+) or red the diaphragm should move to the front.

13. Operation Test

Must be normal at program source same as the power rating.



14. Specification

Items Specifications		Conditions
Size	13.0 x 13.0 x 4.0 (mm)	
Normal Power Rating	0.7 W	
Maximum Power Rating	1.0 W	
Impedance	8.0 Ω	± 15 % at 1000 Hz 1.0 V
Resonant Frequency ($f heta$)	850.0 Hz	± 20 % at 1.0 V
Sound Pressure Level	88.0 dB	± 3.0 dB / 0.7 W power / measuring distance at
		1000 , 1600 , 2000 , 3200 Hz average
Measuring Distance	10.0 cm	
Frequency Range	<i>f</i> 0 ~ 20.0 KHz	
Distortion	5.0 % Max	At 2000 Hz Input 0.7 W
Magnet	Ø 6.0 x 1.0 mm	SMCO
Housing Material	LCP	
Diaphragm Material	Mylar	
Weight	1.1 g	
Operating Temperature	- 30.0 ~ + 85.0 ° C	
Storage Temperature	- 40.0 ~ + 85.0 ° C	
Buzzing and Rattles	2.0 V	Must be normal at this sine wave between



15. Inspection Standard

Item tested	Sym	Standard	AQL	Level	Inspection by	Remarks
					means of	
Sound		Should be within	1	П	Audio analyzer	0.7 W power / measuring distance at
Pressure Level		88.0 ± 3.0 dB				1000 , 1600 , 2000 , 3200 Hz average
Impedance		8.0 Ω	0.65	I	Impedance	± 15 % measured at 1000 Hz at 1.0 V
					Meter	
Outer Diameter		13.0 x 13.0 ± 0.5	1.5	S-3	Electronic	To be measured at the maximum dia.
		(mm)			Calipers	
Height		4.0 ± 0.5 (mm)	1.5	S-3	Electronic	To be measured a t the maximum
					Calipers	height on the body only.
Rust			1	11	Visual	Any rust should not be accepted.
Stain			1.5	11	Visual	There should be no remarkable stains.
Adhesion			1.5	11	Visual	Adhesion should be made sufficiently
						and there should be no outflow of
						adhesive agent.
Other			1.5	П	Visual	
Appearance						



16. Reliability Test

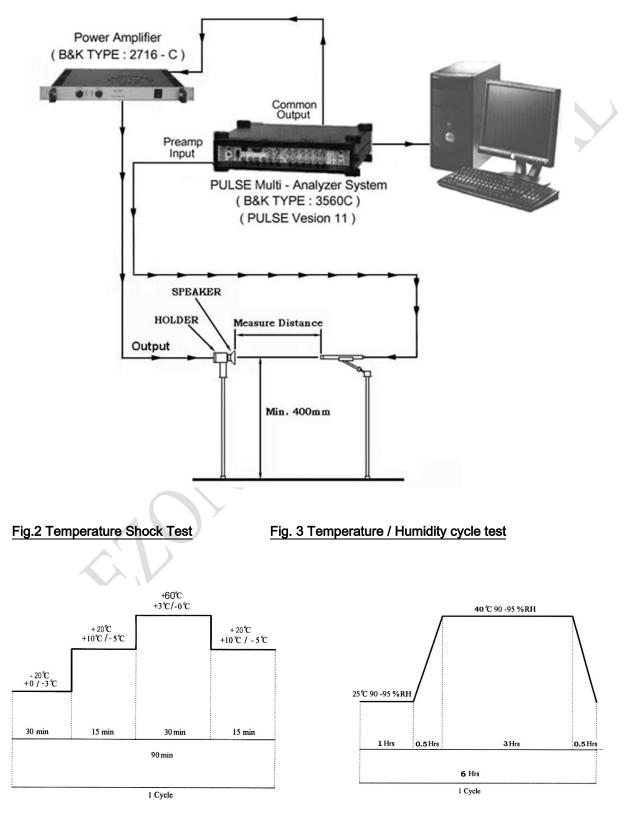
Item	Method of the test	Standard
Storage in high Temperature	Storage in test box for 96 hours under the +85.0 ° C then expose to the room temperature for 1 hours	
Storage in low Temperature	Storage in test box for 96 hours under the –40.0 ° C then expose to the room temperature for 1 hours	
Load Test	Shall be normal after test at white noise source 1W 96 hours	
Temperature Shock Test	Low temperature : - $20.0 \pm 2.0 \circ C$ High temperature : + $60.0 \pm 2.0 \circ C$ Cycle : 1 hour each temp. And then removal back to normal temp for 1 hour.	All specifications must be satisfied after the test.
Temp./ Humidity Cycle Test	Keep 96 hours at 90 to 95 %, + 40.0 \pm 2.0 ° C then removal back to normal temperature for 6 hours	
Drop Test	Drop a speaker contained in normal box into a board 5.0 mm thick 10 times form a height 0.75 m and then test.	

17. Equipment List

Name	Model
Audio Analyzer	Bruel & kjaer
Acoustic Chamber	Bruel & kjaer
Audio Calibrator	Bruel & kjaer
Amplifier	Bruel & kjaer

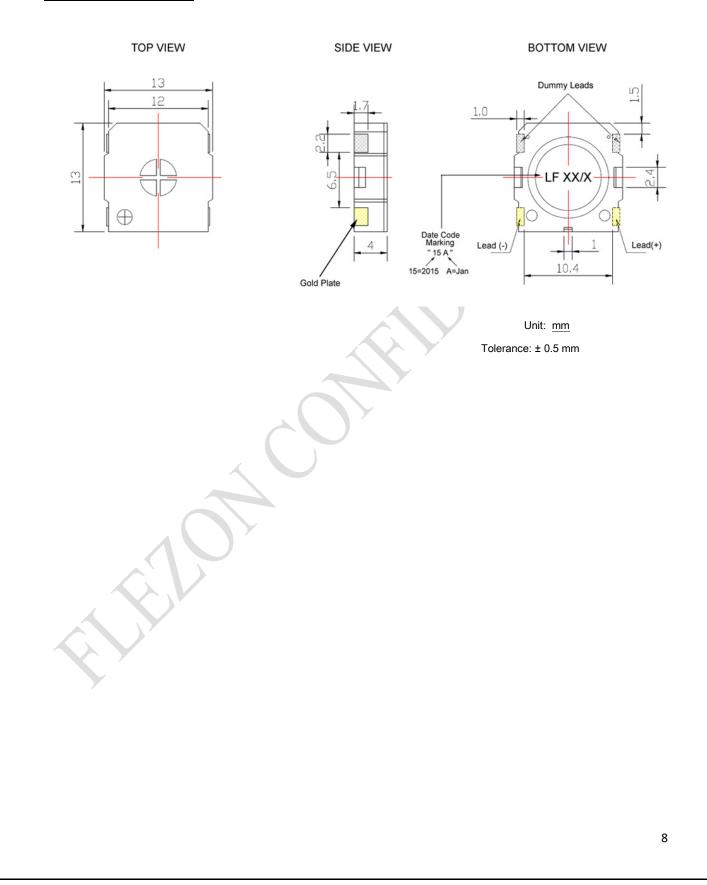


Fig.1 Measuring Method



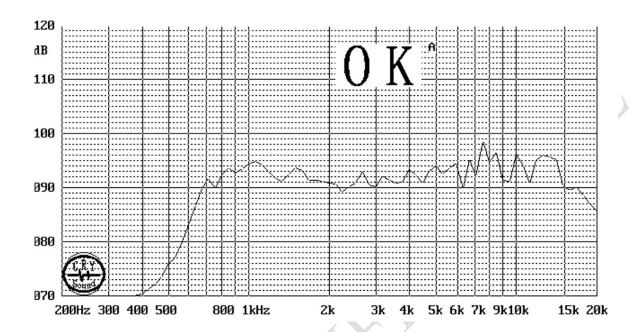


18. Mechanical Draw





19. Frequency Response

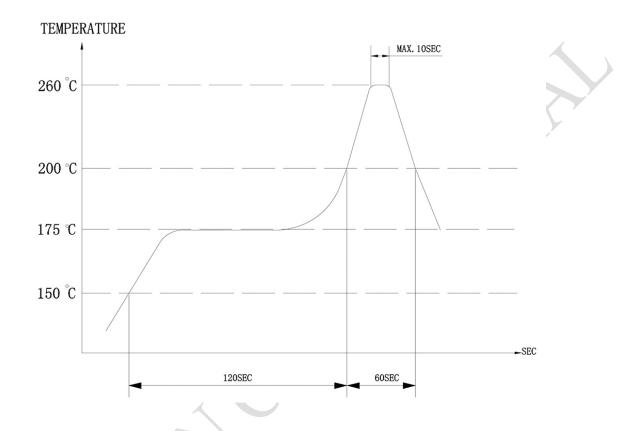




20. Reflow Soldering Condition

(1) Recommendable reflow soldering condition is as follows (Reflow soldering is twice)

Note: It is requested that reflow soldering should be executed after heat of product goes down to normal.



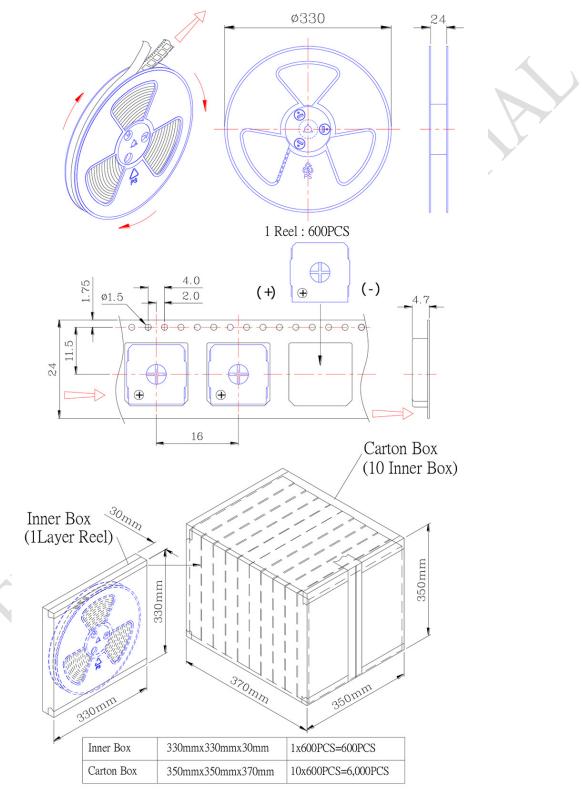
Heat resistant line (Used when heat resistant reliability test is performed)

(2) Manual soldering

Manual soldering temperature 350 °C within 5 sec.



21. Packing Information





22. Change History

Version	Date	Description
1.0	2016.05	First Released